

# 3SK236

Silicon N-Channel Dual Gate MOSFET

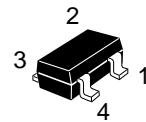
## Application

VHF RF amplifier

## Features

- Excellent cross modulation characteristics
- Capable of low voltage operation

CMPAK-4



1. Source
2. Gate1
3. Gate2
4. Drain

**Table 1 Absolute Maximum Ratings (Ta = 25°C)**

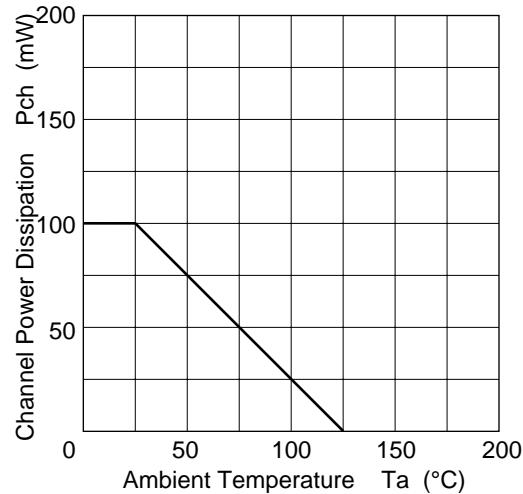
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DS</sub>	12	V
Gate1 to source voltage	V <sub>G1S</sub>	±10	V
Gate2 to source voltage	V <sub>G2S</sub>	±10	V
Drain current	I <sub>D</sub>	35	mA
Channel power dissipation	P <sub>ch</sub>	100	mW
Channel temperature	T <sub>ch</sub>	125	°C
Storage temperature	T <sub>stg</sub>	-55 to +125	°C

Marking is "XX-".

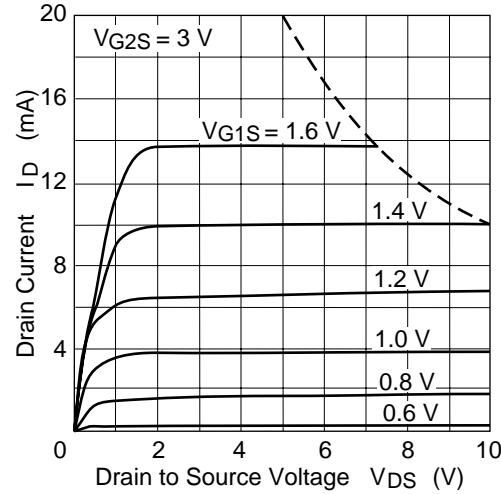
**3SK236****Table 2 Electrical Characteristics (Ta = 25°C)**

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	V <sub>(BR)DSX</sub>	12	—	—	V	I <sub>D</sub> = 200 µA, V <sub>G1S</sub> = -5 V, V <sub>G2S</sub> = -5 V
Gate1 to source breakdown voltage	V <sub>(BR)G1SS</sub>	±10	—	—	V	I <sub>G1</sub> = ±10 µA, V <sub>G2S</sub> = V <sub>DS</sub> = 0
Gate2 to source breakdown voltage	V <sub>(BR)G2SS</sub>	±10	—	—	V	I <sub>G2</sub> = ±10 µA, V <sub>G1S</sub> = V <sub>DS</sub> = 0
Gate1 leakage current	I <sub>G1SS</sub>	—	—	±100	nA	V <sub>G1S</sub> = ±8 V, V <sub>G2S</sub> = V <sub>DS</sub> = 0
Gate2 leakage current	I <sub>G2SS</sub>	—	—	±100	nA	V <sub>G2S</sub> = ±8 V, V <sub>G1S</sub> = V <sub>DS</sub> = 0
Drain current	I <sub>DSS</sub>	0	—	1	mA	V <sub>DS</sub> = 4 V, V <sub>G1S</sub> = 0, V <sub>G2S</sub> = 3 V
Gate1 to source cutoff voltage	V <sub>G1S(off)</sub>	0	—	+1.0	V	V <sub>DS</sub> = 6 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 100 µA
Gate2 to source cutoff voltage	V <sub>G2S(off)</sub>	0	—	+1.0	V	V <sub>DS</sub> = 6 V, V <sub>G1S</sub> = 3 V, I <sub>D</sub> = 100 µA
Forward transfer admittance	Y <sub>fs</sub>	13	17	—	mS	V <sub>DS</sub> = 6 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 10 mA, f = 1 kHz
Input capacitance	C <sub>iss</sub>	2.5	3.5	4.5	pF	V <sub>DS</sub> = 6 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 10 mA, f = 1 MHz
Output capacitance	C <sub>oss</sub>	1.0	1.4	1.8	pF	
Reverse transfer capacitance	C <sub>rss</sub>	—	0.018	0.03	pF	
Power gain	PG	22	27.6	—	dB	V <sub>DS</sub> = 4 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 10 mA, f = 200 MHz
Noise figure	NF	—	1.77	2.7	dB	

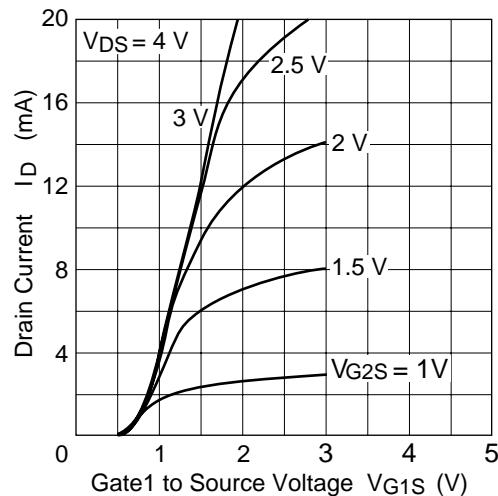
Maximum channel power dissipation curve



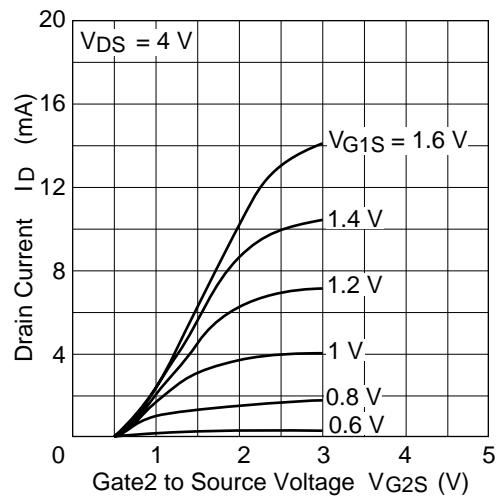
Typical output characteristics

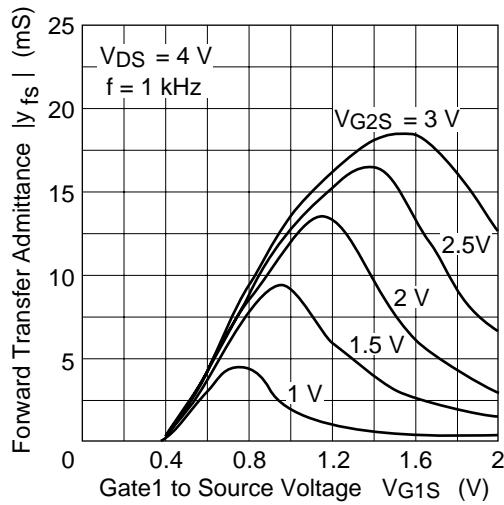


Drain current vs. gate1 to source voltage

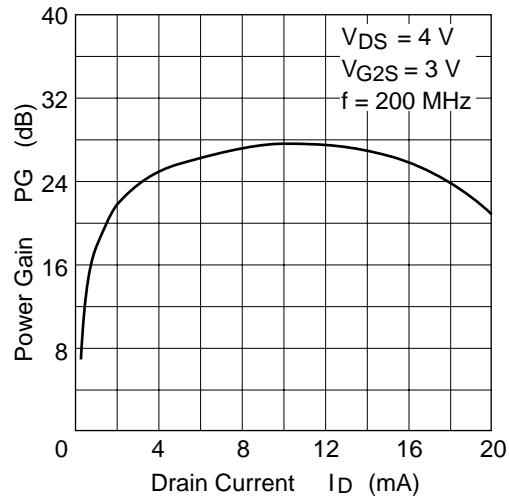


Drain current vs. gate2 to source voltage



**3SK236**Forward transfer admittance  
vs. gate1 to source voltage

Power gain vs. drain current



Noise figure vs. drain current

